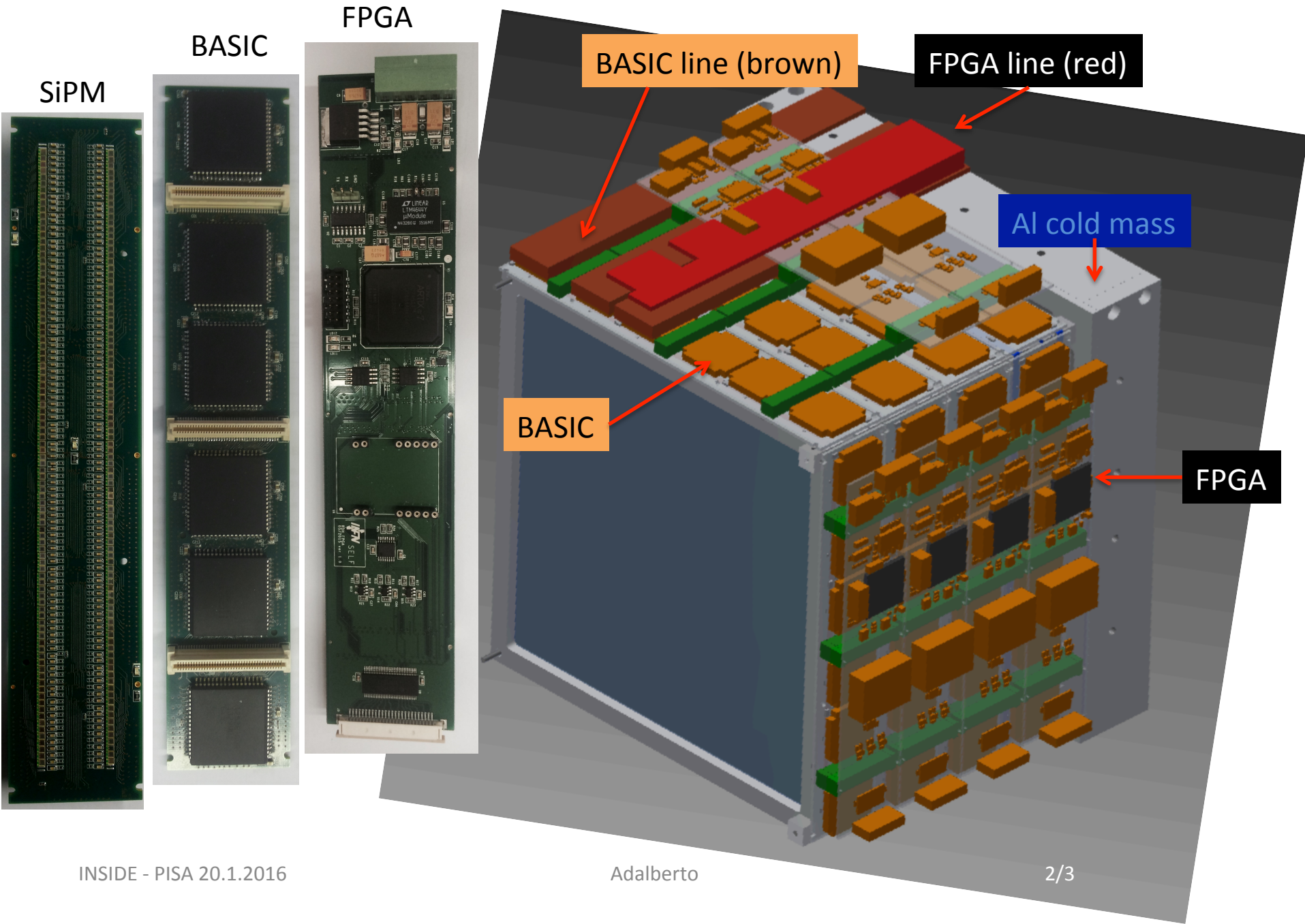
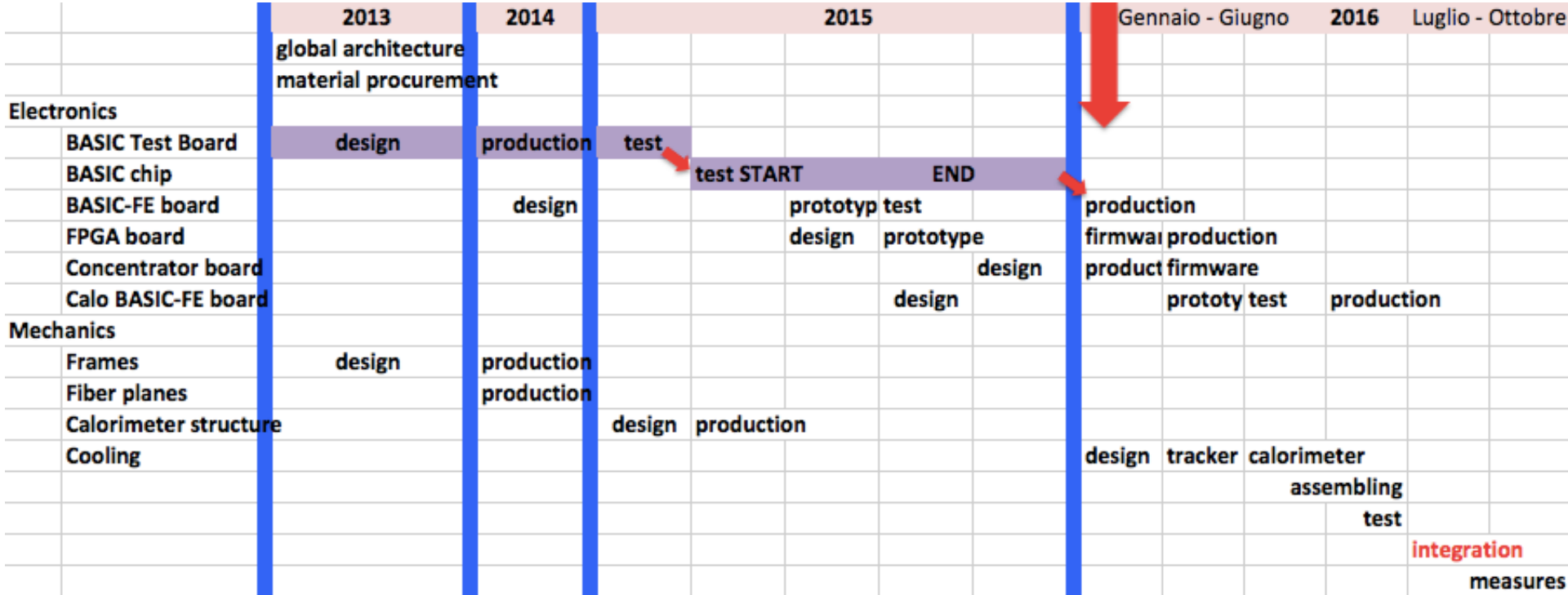


cooling first study with the final electronics dimensions





The critical path was the characterization of the 150 BASIC32\_ADC chips

Since last week a lot of activities started/restarted:

- BASIC board production
- FPGA and Concentrator firmware
- cooling

The assembling of the Profiler is expected for the summer; the integration will follow

